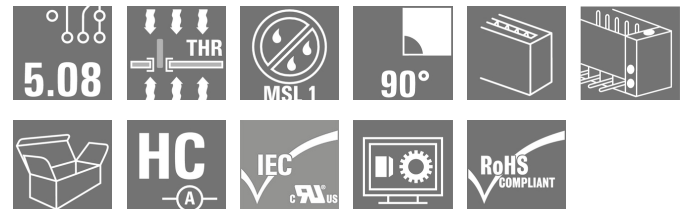


SL-SMT 5.08HC/05/90F 3.2SN BK BX
Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com


High-temperature-resistant pin header, packed in box or tape. On tape, with 1.5 mm solder pin, optimised for automatic assembly. 3.2 mm solder pin suitable for reflow and wave soldering. The pin headers provide space for labelling and can be coded. HC = High Current.

General ordering data

Version	PCB plug-in connector, male header, Flange, THT/THR solder connection, 5.08 mm, Number of poles: 5, 90°, Solder pin length (l): 3.2 mm, tinned, black, Box
Order No.	1837660000
Type	SL-SMT 5.08HC/05/90F 3.2SN BK BX
GTIN (EAN)	4032248347476
Qty.	48 pc(s).
Product data	IEC: 400 V / 27.5 A UL: 300 V / 18.5 A
Packaging	Box

Creation date March 25, 2021 3:17:48 PM CET

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Technical data

Dimensions and weights

Depth	12 mm	Depth (inches)	0.472 inch
Height	11.7 mm	Height (inches)	0.461 inch
Height of lowest version	8.5 mm	Net weight	3.44 g
Width	35.56 mm	Width (inches)	1.4 inch

System specifications

Product family	OMNIMATE Signal - series BL/SL 5.08			
Type of connection	Board connection			
Mounting onto the PCB	THT/THR solder connection			
Pitch in mm (P)	5.08 mm			
Pitch in inches (P)	0.2 inch			
Outgoing elbow	90°			
Number of poles	5			
Number of solder pins per pole	1			
Solder pin length (l)	3.2 mm			
Solder pin length tolerance	0 / -0.3 mm			
Solder pin dimensions	d = 1.2 mm, Octagonal			
Solder eyelet hole diameter (D)	1.4 mm			
Solder eyelet hole diameter tolerance (D)	+ 0.1 mm			
L1 in mm	20.32 mm			
L1 in inches	0.8 inch			
Number of rows	1			
Pin series quantity	1			
Volume resistance	≤5 mΩ			
Can be coded	Yes			
Plugging force/pole, max.	9 N			
Pulling force/pole, max.	7 N			
Tightening torque	Torque type	Mounting screw, PCB		
	Usage information	Tightening torque	min.	0.15 Nm
			max.	0.2 Nm
		Recommended screw	Part number	PTSC KA 2.2X4.5 WN1412

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	CuMg
Contact surface	tinned	Layer structure of solder connection	1...3 µm Ni / 2...4 µm Sn matt
Layer structure of plug contact	1...3 µm Ni / 2...4 µm Sn matt	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	100 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	100 °C		

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Technical data

Rated data acc. to IEC

tested acc. to standard

IEC 60664-1, IEC 61984

Rated current, max. number of poles
(Tu=20°C)

19 A

Rated current, max. number of poles
(Tu=40°C)

16.5 A

Rated voltage for surge voltage class /
pollution degree III/2

320 V

Rated impulse voltage for surge voltage
class/ pollution degree II/2

4 kV

Rated impulse voltage for surge voltage
class/ contamination degree III/3

4 kV

Rated current, min. number of poles
(Tu=20°C)

27.5 A

Rated current, min. number of poles
(Tu=40°C)

24 A

Rated voltage for surge voltage class /
pollution degree II/2

400 V

Rated voltage for surge voltage class /
pollution degree III/3

250 V

Rated impulse voltage for surge voltage
class/ pollution degree III/2

4 kV

Rated data acc. to CSA

Institute (CSA)



Certificate No. (CSA)

200039-1176845

Rated voltage (Use group B / CSA)

300 V

Rated voltage (Use group D / CSA)

300 V

Rated current (Use group B / CSA)

18.5 A

Rated current (Use group D / CSA)

18.5 A

Reference to approval values

Specifications are
maximum values, details -
see approval certificate.

Rated data acc. to UL 1059

Institute (UR)



Certificate No. (UR)

E60693

Rated voltage (Use group B / UL 1059)

300 V

Rated voltage (Use group D / UL 1059)

300 V

Rated current (Use group B / UL 1059)

18.5 A

Rated current (Use group D / UL 1059)

10 A

Reference to approval values

Specifications are
maximum values, details -
see approval certificate.

Packing

Packaging

Box

VPE length

40 mm

VPE width

60 mm

VPE height

180 mm

Classifications

ETIM 6.0

EC002637

ETIM 7.0

EC002637

ECLASS 9.0

27-44-04-02

ECLASS 9.1

27-44-04-02

ECLASS 10.0

27-44-04-02

ECLASS 11.0

27-46-02-01

SL-SMT 5.08HC/05/90F 3.2SN BK BX**Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com**Technical data****Important note**

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	• Gold-plated contact surfaces on request • Rated current related to rated cross-section & min. No. of poles. • Diameter of solder eyelet $D = 1.4 \pm 0.1 \text{ mm}$ • Solder eyelet diameter $D = 1.5 \pm 0.1 \text{ mm}$, from 9 poles • P on drawing = pitch • Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards. • Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months

Approvals

Approvals



ROHS	Conform
UL File Number Search	E60693

Downloads

Approval/Certificate/Document of Conformity	Declaration of the Manufacturer
Engineering Data	WSCAD

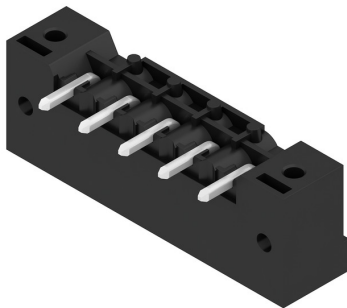
SL-SMT 5.08HC/05/90F 3.2SN BK BX

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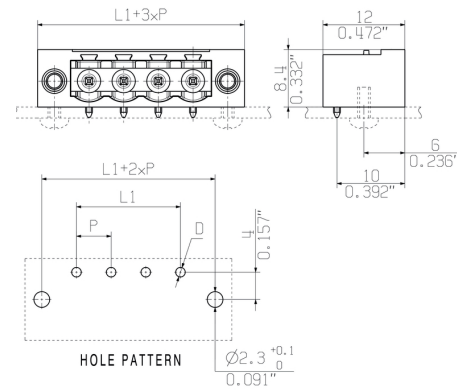
www.weidmueller.com

Drawings

Product image



Dimensional drawing



Product benefits



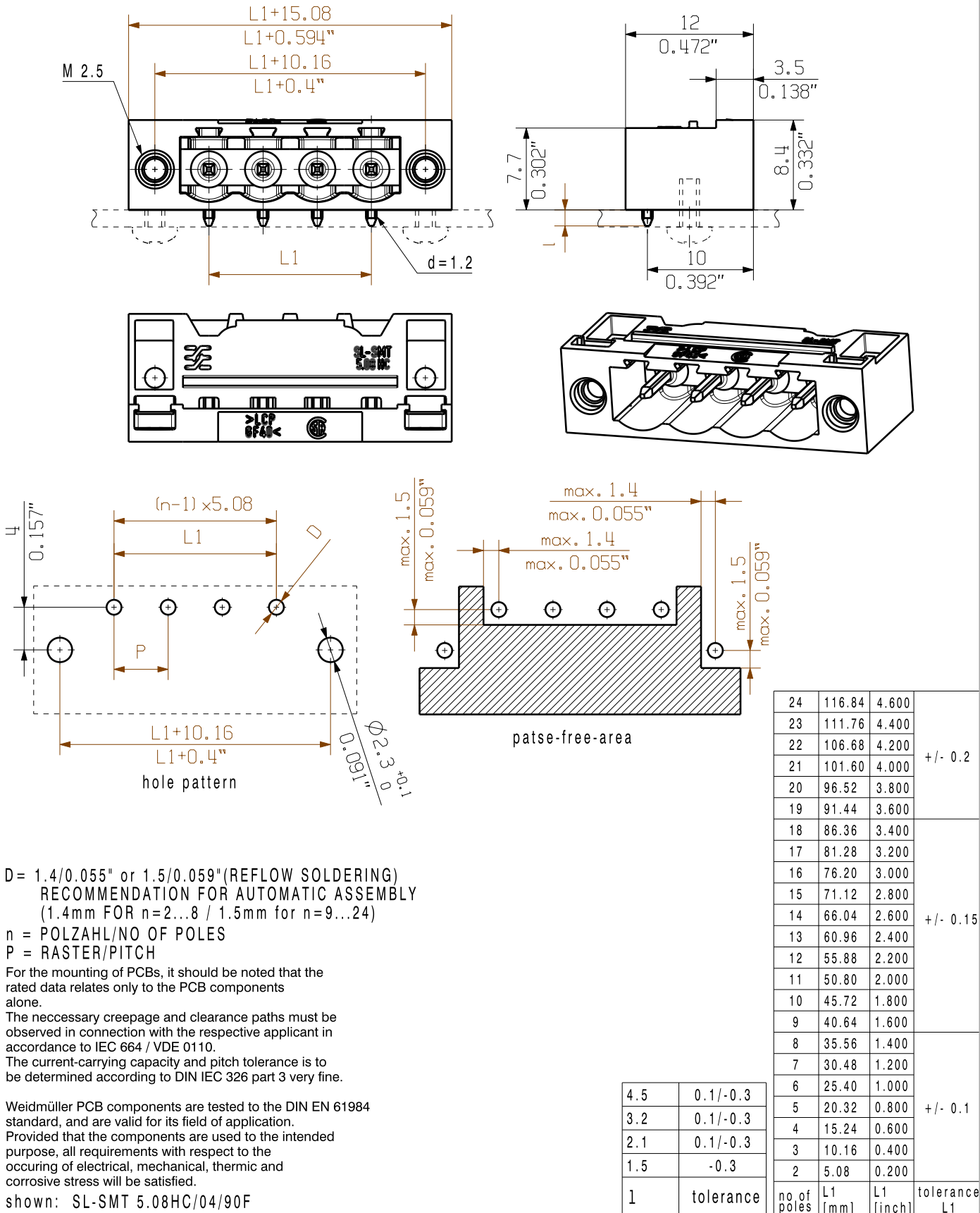
Safe power transmission
Proven properties

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Dimensions without tolerances are no check dimensions

The English version is binding



	DIN ISO 2768-m	106339/4 30.07.18 HERTEL_S	00		Cat.no.: .
	Modification	Date	Name		
	Drawn	29.11.2007	HELIS_MA	SL-SMT 5.08HC/.../90... STIFTELEISTE MALE HEADER	2 33262 31 Drawing no. Issue no. Sheet 04 of 04 sheets
	Responsible		HERTEL_S		
	Checked	01.08.2018	KOCH_JG		
Supersedes: .	Approved		LANG_T	Product file: SL-SMT 5.08	7280

Recommended wave soldering profiles

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 16
D-32758 Detmold
Germany
Fon: +49 5231 14-0
Fax: +49 5231 14-292083
www.weidmueller.com

Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

Recommended reflow soldering profile

Weidmüller Interface GmbH & Co. KG

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D-32758 Detmold

Germany

Fon: +49 5231 14-0

Fax: +49 5231 14-292083

www.weidmueller.com



Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.